40-Channel Symmetric Row Driver

Features

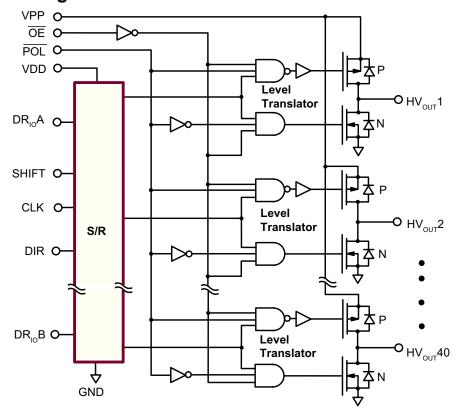
- ► HVCMOS® technology
- Symmetric row drive (reduces latent imaging in ACTFEL displays)
- ► Output voltage up to +240V
- ▶ Low power level shifting
- Source/sink current minimum 70mA
- ► Shift register speed 3.0MHz
- ▶ Pin-programmable shift direction (DIR, SHIFT)

General Description

The HV7224 is a low-voltage serial to high-voltage parallel converter with push-pull outputs. It is especially suitable for use as a symmetric row driver in AC thin-film electroluminescent (ACTFEL) displays.

When the data reset pin ($DR_{IO}A/DR_{IO}B$) is at logic high, it will reset all the outputs of the internal shift register to zero. At the same time, the output of the shift register will start shifting a logic high from the least significant bit to the most significant bit. The $DR_{IO}A/DR_{IO}B$ can be triggered at any time. The DIR and SHIFT pins control the direction of data shift through the device. When DIR is at logic high, $DR_{IO}A$ is the input and $DR_{IO}B$ is the output. When DIR is grounded, $DR_{IO}B$ is the input and the $DR_{IO}A$ is the output. See the Output Sequence Operation Table for output sequence. The \overline{POL} and \overline{OE} pins perform the polarity select and output enable function respectively. Data is loaded on the low to high transition of the clock. A logic high will cause the output to swing to VPP if \overline{POL} is high, or to GND if \overline{POL} is low. All outputs will be in High-Z state if \overline{OE} is at logic high. Data output buffers are provided for cascading devices.

Functional Block Diagram



Ordering Information

	Package Option
Device	64-Lead PQFP (3-sided) 20.00x14.00mm body 3.40mm height (max) 0.80mm pitch 3.90mm footprint
HV7224	HV7224PG-G

⁻G indicates package is RoHS compliant ('Green')

Absolute Maximum Ratings

Parameter	Value
Supply voltage, V _{DD}	-0.5V to +7.0V
Supply voltage , V _{PP}	-0.5V to +260V
Logic input levels	-0.5V to V _{DD} + 0.5V
Continuous total power dissipation ¹	1200mW
Operating temperature range	-40°C to +85°C
Storage temperature range	-65°C to +150°C
Lead temperature 1.6mm from case for 10 seconds	260°C

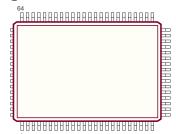
Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

Note:

For operation above 25°C ambient derate linearly to maximum operating temperature at 20mW/°C.



Pin Configuration



64-Lead PQFP (3-sided) (PG) (top view)

Product Marking



L = Lot Number YY = Year Sealed WW = Week Sealed C = Country of Origin A = Assembler ID

= "Green" Packaging

Package may or may not include the following marks: Si or 🇌



64-Lead PQFP (3-sided) (PG)

Recommended Operating Conditions

Sym	Parameter	Min	Max	Units
$V_{\scriptscriptstyle DD}$	Logic supply voltage	4.5	5.5	V
V _{PP}	High voltage supply ¹	0	240	V
V _{IH}	High-level input voltage	0.7 V _{DD}	V _{DD}	V
V _{IL}	Low-level input voltage	0	0.2V _{DD}	V
f _{CLK}	Clock frequency	-	3.0	MHz
T _A	Operating free-air temperature	-40	+85	°C
Io	High voltage output current	-	±70	mA
I _{OD}	Allowable pulsed current through output diode	-	±300	mA

Note:

Output will not switch at $V_{PP} = 0V$.

Power-up sequence should be the following:

- Connect ground.
- 2. Apply V_{DD}.
- Set all inputs (Data, CLK, Enable, etc.) to a known state.

The V_{PP} should not drop below V_{DD} or float during operation.

Power-down sequence should be the reverse of the above.

DC Electrical Characteristics

(over recommended operating conditions of V_{DD} = 5.0V, V_{PP} = 240V, and T_A = 25°C unless noted)

Sym	Parameter		Min	Max	Units	Conditions
I _{DD}	V _{DD} supply current		ı	10	mA	$f_{CLK} = 3.0MHz, V_{DD} = 5.5V$
	V aupply aurrent		ı	2.0	mA	All outputs low or High-Z
l _{PP}	V _{PP} supply current		ı	4.0	mA	One output high ¹
I _{DDQ}	Quiescent V _{DD} supply current		ı	100	μA	All V_{IN} = GND or V_{DD}
V	High lovel output	HV _{out}	190	-	V	I _o = -70mA
V _{OH}	High-level output	DATA OUT	4.5	-	V	I _O = -100μA
\/	Low lovel output	HV _{out}	-	50	V	I _o = +70mA
V _{OL}	Low-level output	DATA OUT	-	0.5	V	I _O = +100μA
I _{IH}	High-level logic input current		-	1.0	μA	$V_{IH} = V_{DD}$
I _{IL}	Low-level logic input current		-	-1.0	μA	V _{IL} = 0V
	UV seturation current	P-channel	-80	-	mA	
SAT	I _{SAT} HV _{OUT} saturation current	N-channel	75	-	mA	

Note:

AC Electrical Characteristics

 $(V_{\scriptscriptstyle DD}$ = 5.0V and $T_{\scriptscriptstyle A}$ = 25°C)

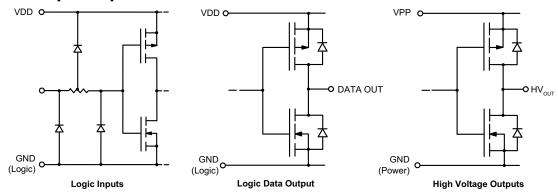
Sym	Parameter	Min	Max	Units	Conditions
f _{CLK}	Clock frequency	-	3.0	MHz	Per register, C _L = 15pF
t _{wh} , t _{wL}	Clock width high or low	150	-	ns	
t _{sud}	Data set-up time before clock rises	50	-	ns	
t _{HD}	Data hold time after clock rises	50	-	ns	
t _{suc}	HV _{OUT} delay from clock rises (Hi-Z to H or L)	-	1.0	μs	$C_{L} = 330 pF // R_{L} = 10 k\Omega$
t _{sue}	HV _{OUT} delay from Output Enable falls	-	600	ns	$C_{L} = 330 pF // R_{L} = 10 k\Omega$
t _{HC}	HV _{OUT} delay from clock rises (H or L to Hi-Z)	-	2.0	μs	$C_{L} = 330 pF // R_{L} = 10 k\Omega$
t _{HE}	HV _{OUT} delay from Output Enable rises	-	600	ns	$C_{L} = 330 pF // R_{L} = 10 k\Omega$
t _{DHL}	Delay time clock to data output falls*	-	250	ns	C _L = 15pF
t _{DLH}	Delay time clock to data output rises*	-	250	ns	C _L = 15pF
t _{ONF}	HV _{OUT} fall time	-	2.0	μs	$C_{L} = 330 pF // R_{L} = 10 k\Omega$
t _{onr}	HV _{OUT} rise time	-	2.0	μs	$C_{L} = 330 pF // R_{L} = 10 k\Omega$
t _{POW}	POL pulse width	3.0	-	μs	
t _{oew}	Output Enable pulse width	3.0	-	μs	
SR	Slew rate, V _{PP}	-	45	V/µs	One active output driving 4.7nF load

Note:

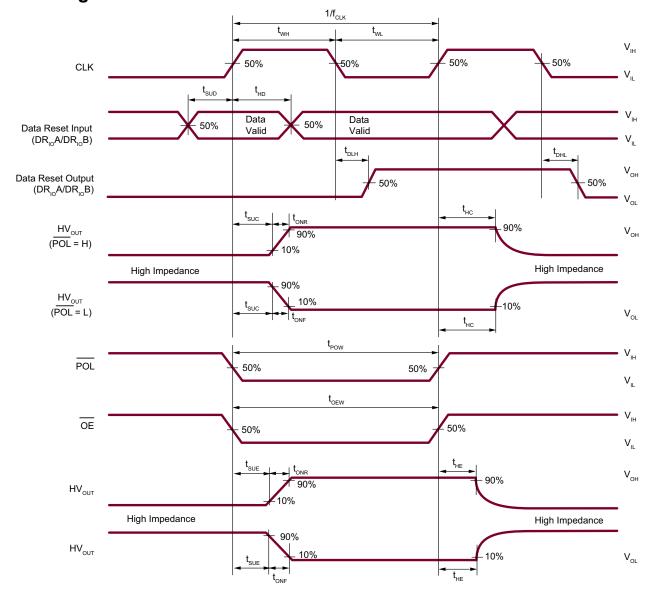
^{1.} Only one output can be turned on at a time.

^{*} The delay is measured from the trailing edge of the clock but the data is triggered by the rising edge of the clock. There is an internal delay for the data output which is equal to t_{w-r}.

Input and Output Equivalent Circuits



Switching Waveforms



Function Table

I/O Relations			Inputs			HV Outputs
I/O Relations	CLK	DIR	S/R DATA	POL	ŌĒ	HV Outputs
O/P HIGH	X	X	Н	Н	L	Н
O/P OFF	X	X	L	X	L	HIGH-Z
O/P LOW	Х	Х	Н	L	L	L
O/P OFF	X	X	Х	Х	Н	All O/P HIGH-Z

Notes:

 $H = logic \ high \ level, \ L = logic \ low \ level, \ X = irrelevant$

Data input (DR_{IO}) loaded on the low-to-high transition of the clock.

Only one active output can be set at a time.

Output Sequence Operation Table

DIR	SHIFT	Data Reset In	Data Reset Out	HV _{out} # Sequence	Direction*
L	L	DR _{IO} B	DR _{IO} A ¹	40 → 1	\sim
Н	L	DR _{IO} A	DR _{IO} B ²	1 → 40	•
L	Н	DR _{IO} B	DR _{IO} A ¹	$20 \rightarrow 1 \rightarrow 40 \rightarrow 21$	\frown
Н	Н	DR _{IO} A	DR _{IO} B ²	$21 \rightarrow 40 \rightarrow 1 \rightarrow 20$	$ \uparrow $

Notes:

- * Reference to package outline or chip layout drawing.
- 1. DR_{Io}A is DR_{Io}B delayed by 40 clock pulses.
- 2. DR₁₀B is DR₁₀A delayed by 40 clock pulses.

Pin Descriptions - 64-Lead PQFP (3-sided) (PG) Option A

Pin #	Function
1	HV _{out} 1/40
2	HV _{OUT} 2/39
3	HV _{OUT} 3/38
4	HV _{оυт} 4/37
5	HV _{out} 5/36
6	HV _{OUT} 6/35
7	HV _{оит} 7/34
8	HV _{OUT} 8/33
9	HV _{оит} 9/32
10	HV _{оυт} 10/31
11	HV _{OUT} 11/30
12	HV _{оυт} 12/29
13	HV _{OUT} 13/28
14	HV _{OUT} 14/27
15	HV _{оυт} 15/26
16	HV _{оυт} 16/25

HV _{OUT} 17/24 HV _{OUT} 18/23
HV _{оυт} 19/22
HV _{оит} 20/21
VPP
N/C
GND (Power)
GND (Logic)
DIR
VDD
CLK
N/C
SHIFT
N/C
DR _{IO} A
N/C

33	N/C
34	DR _{IO} B
35	ŌĒ
36	N/C
37	POL
38	N/C
39	VDD
40	N/C
41	GND (Logic)
42	GND (Power)
43	N/C
44	VPP
45	HV _{OUT} 21/20
46	HV _{OUT} 22/19
47	HV _{OUT} 23/18
48	HV _{OUT} 24/17

Pin #	Function
49	HV _{оит} 25/16
50	HV _{оит} 26/15
51	HV _{оит} 27/14
52	HV _{оит} 28/13
53	HV _{OUT} 29/12
54	HV _{оит} 30/11
55	HV _{оит} 31/10
56	HV _{OUT} 32/9
57	HV _{OUT} 33/8
58	HV _{оит} 34/7
59	HV _{оит} 35/6
60	HV _{out} 36/5
61	HV _{OUT} 37/4
62	HV _{оит} 38/3
63	HV _{оит} 39/2
64	HV _{out} 40/1

Note:

Pin designation for DIR H/L, Shift = L Example: For DIR = H, pin 1 is $HV_{OUT}1$ For DIR = L, pin 1 is $HV_{OUT}40$

Pin Descriptions - 64-Lead PQFP (3-sided) (PG) Option B

Pin #	Function
1	HV _{оит} 20/21
2	HV _{OUT} 19/22
3	HV _{оυт} 18/23
4	HV _{OUT} 17/24
5	HV _{оυт} 16/25
6	HV _{OUT} 15/26
7	HV _{OUT} 14/27
8	HV _{OUT} 13/28
9	HV _{OUT} 12/29
10	HV _{оυт} 11/30
11	HV _{оυт} 10/31
12	HV _{OUT} 9/32
13	HV _{OUT} 8/33
14	HV _{OUT} 7/34
15	HV _{OUT} 6/35
16	HV _{OUT} 5/36

Pin #	Function								
17	HV _{OUT} 4/37								
18	HV _{OUT} 3/38								
19	HV _{OUT} 2/39								
20	HV _{OUT} 1/40								
21	VPP								
22	N/C								
23	GND (Power)								
24	GND (Logic)								
25	DIR								
26	VDD								
27	CLK								
28	N/C								
29	SHIFT								
30	N/C								
31	DR _{IO} A								
32	N/C								

Pin #	Function							
33	N/C							
34	DR _{IO} B							
35	ŌĒ							
36	N/C							
37	POL							
38	N/C							
39	VDD							
40	N/C							
41	GND (Logic)							
42	GND (Power)							
43	N/C							
44	VPP							
45	HV _{OUT} 40/1							
46	HV _{OUT} 39/2							
47	HV _{OUT} 38/3							
48	HV _{OUT} 37/4							

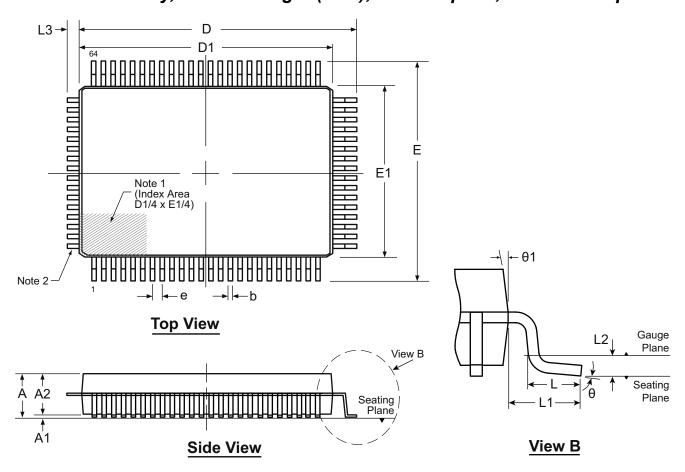
Pin #	Function
49	HV _{OUT} 36/5
50	HV _{ουτ} 35/6
51	HV _{оит} 34/7
52	HV _{ουτ} 33/8
53	HV _{ουτ} 32/9
54	HV _{ουτ} 31/10
55	HV _{оυт} 30/11
56	HV _{оυт} 29/12
57	HV _{ουτ} 28/13
58	HV _{ουτ} 27/14
59	HV _{ουτ} 26/15
60	HV _{ουτ} 25/16
61	HV _{оυт} 24/17
62	HV _{оυт} 23/18
63	HV _{ουτ} 22/19
64	HV _{ουτ} 21/20

Note:

Pin designation for DIR H/L, Shift = H Example: For DIR = H, pin 1 is $HV_{OUT}20$ For DIR = L, pin 1 is $HV_{OUT}21$

64-Lead PQFP (3-sided) Package Outline (PG)

20.00x14.00mm body, 3.40mm height (max), 0.80mm pitch, 3.90mm footprint



Note:

- A Pin 1 identifier must be located in the index area indicated. The Pin 1 Identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.
- The leads on this side are trimmed.

Symi	ool	Α	A1	A2	b	D	D1	E	E1	е	L	L1	L2	L3	θ	θ1
Dimen- sion (mm)	MIN	2.80	0.25	2.55	0.30	22.25	19.80	17.65	13.80		0.73	1.95 REF	0.25 BSC	0.55 REF	0 °	5°
	NOM	-	-	2.80	-	22.50	20.00	17.90	14.00	0.80 BSC	0.88				3.5°	-
	MAX	3.40	0.50	3.05	0.45	22.75	20.20	18.15	14.20		1.03				7 °	16º

Drawings not to scale.

Supertex Doc. #: DSPD-64PQFPPG, Version NR090608.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to http://www.supertex.com/packaging.html.)

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